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GANKIBAN Type: CN10MM

GaN Wafers

GaN wafers enable "GaN-on-GaN" structure of GaN-based optoelectronic and electronic devices such as blue/green laser diodes, light emitting diodes, high-power switching transistors, and RF transistors. GANKIBAN CN10MM is an n⁺ wafer produced by SixPoint's proprietary NEAT (near equilibrium ammonothermal) method. High carrier concentration attains low series resistance for reduction of heat generation during high-current operation, It is suitable for vertical devices including edge-emitting laser diodes, vertical high-power pn diodes and vertical high-power transistors.

Applications

R&D of GaN-based devices using homoepitaxy

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Wafer size	10 x 10 mm, with m-plane flat, usable area > 90%
Wafer thickness	300 ~ 400 micron
Orientation	C plane
	Miscut angle 0°+/-0.2° toward A, 0.4°+/-0.2° toward M
Surface finish	Ga-face CMP
	N-face as processed
XRD FWHM from (002)	< 200 arcsec (typical value is 100 arcsec)
Conduction type	n⁺-type (n > 1x10 ¹⁹ cm⁻³)

Specifications





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